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Intel - EPF81500ARC304-3 Datasheet



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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

2014.10	
Product Status	Obsolete
Number of LABs/CLBs	162
Number of Logic Elements/Cells	1296
Total RAM Bits	-
Number of I/O	208
Number of Gates	16000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	304-BFQFP
Supplier Device Package	304-RQFP (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf81500arc304-3

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FLEX 8000 devices contain an optimized microprocessor interface that permits the microprocessor to configure FLEX 8000 devices serially, in parallel, synchronously, or asynchronously. The interface also enables the microprocessor to treat a FLEX 8000 device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to create configuration software.

The FLEX 8000 family is supported by Altera's MAX+PLUS II development system, a single, integrated package that offers schematic, text—including the Altera Hardware Description Language (AHDL), VHDL, and Verilog HDL—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The MAX+PLUS II software provides EDIF 2 0 0 and 3 0 0, library of parameterized modules (LPM), VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industrystandard PC- and UNIX workstation-based EDA tools. The MAX+PLUS II software runs on Windows-based PCs and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations.

The MAX+PLUS II software interfaces easily with common gate array EDA tools for synthesis and simulation. For example, the MAX+PLUS II software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the MAX+PLUS II software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the MAX+PLUS II development system includes DesignWare functions that are optimized for the FLEX 8000 architecture.



Functional Description For more information on the MAX+PLUS II software, go to the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet*.

The FLEX 8000 architecture incorporates a large matrix of compact building blocks called logic elements (LEs). Each LE contains a 4-input LUT that provides combinatorial logic capability and a programmable register that offers sequential logic capability. The fine-grained structure of the LE provides highly efficient logic implementation.

Eight LEs are grouped together to form a logic array block (LAB). Each FLEX 8000 LAB is an independent structure with common inputs, interconnections, and control signals. The LAB architecture provides a coarse-grained structure for high device performance and easy routing.

Figure 1 shows a block diagram of the FLEX 8000 architecture. Each group of eight LEs is combined into an LAB; LABs are arranged into rows and columns. The I/O pins are supported by I/O elements (IOEs) located at the ends of rows and columns. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an input or output register.



Signal interconnections within FLEX 8000 devices and between device pins are provided by the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. IOEs are located at the end of each row (horizontal) and column (vertical) FastTrack Interconnect path.

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The MAX+PLUS II Compiler can create cascade chains automatically during design processing; designers can also insert cascade chain logic manually during design entry. Cascade chains longer than eight LEs are automatically implemented by linking LABs together. The last LE of an LAB cascades to the first LE of the next LAB.

Figure 5 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. For a device with an A-2 speed grade, the LE delay is 2.4 ns; the cascade chain delay is 0.6 ns. With the cascade chain, 4.2 ns is needed to decode a 16-bit address.



Figure 5. FLEX 8000 Cascade Chain Operation

LE Operating Modes

The FLEX 8000 LE can operate in one of four modes, each of which uses LE resources differently. See Figure 6. In each mode, seven of the ten available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. The three remaining inputs to the LE provide clock, clear, and preset control for the register. The MAX+PLUS II software automatically chooses the appropriate mode for each application. Design performance can also be enhanced by designing for the operating mode that supports the desired application.

Figure 6. FLEX 8000 LE Operating Modes



Arithmetic Mode



Up/Down Counter Mode



Clearable Counter Mode



Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in signal are the inputs to a 4-input LUT. Using a configurable SRAM bit, the MAX+PLUS II Compiler automatically selects the carry-in or the DATA3 signal as an input. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. The LE-Out signal—the data output of the LE—is either the combinatorial output of the LUT and cascade chain, or the data output (Q) of the programmable register.

Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT provides a 3-bit function; the other generates a carry bit. As shown in Figure 6, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three bits: a, b, and the carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports a cascade chain.

Up/Down Counter Mode

The up/down counter mode offers counter enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals, without using the LUT resources.

Clearable Counter Mode

The clearable counter mode is similar to the up/down counter mode, but supports a synchronous clear instead of the up/down control; the clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer, and the output of this multiplexer is ANDed with a synchronous clear.

Internal Tri-State Emulation

Internal tri-state emulation provides internal tri-stating without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable signals select the signal that drives the bus. However, if multiple output enable signals are active, contending signals can be driven onto the bus. Conversely, if no output enable signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The MAX+PLUS II software automatically implements tri-state bus functionality with a multiplexer.

Clear & Preset Logic Control

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE is used to asynchronously load signals into a register. The register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

During compilation, the MAX+PLUS II Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six asynchronous modes, which are chosen during design entry. LPM functions that use registers will automatically use the correct asynchronous mode. See Figure 7.

- Clear only
- Preset only
- Clear and preset
- Load with clear
- Load with preset
- Load without clear or preset

Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLEX 8000 FastTrack Interconnect Resources							
Device	Rows	Channels per Row	Columns	Channels per Column			
EPF8282A EPF8282AV	2	168	13	16			
EPF8452A	2	168	21	16			
EPF8636A	3	168	21	16			
EPF8820A	4	168	21	16			
EPF81188A	6	168	21	16			
EPF81500A	6	216	27	16			

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.



Figure 12. FLEX 8000 Column-to-IOE Connections

In addition to general-purpose I/O pins, FLEX 8000 devices have four dedicated input pins. These dedicated inputs provide low-skew, device-wide signal distribution, and are typically used for global clock, clear, and preset control signals. The signals from the dedicated inputs are available as control signals for all LABs and I/O elements in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Signals enter the FLEX 8000 device either from the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOEs are located at the ends of the row and column interconnect channels.

I/O pins can be used as input, output, or bidirectional pins. Each I/O pin has a register that can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The MAX+PLUS II Compiler uses the programmable inversion option to invert signals automatically from the row and column interconnect when appropriate.

The clock, clear, and output enable controls for the IOEs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or by internal logic. The IOE control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This "peripheral bus" can be configured to provide up to four output enable signals (10 in EPF81500A devices), and up to two clock or clear signals. Figure 13 on page 22 shows how two output enable signals are shared with one clock and one clear signal.

MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of V_{CC} pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V V_{CCINT} level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with V_{CCIO} levels lower than 4.75 V incur a nominally greater timing delay of t_{OD2} instead of t_{OD1} . See Table 8 on page 26.

IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in Table 6.

Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions				
JTAG Instruction	Description			
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins			
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.			
BYPASS	Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.			

FLEX 8000 Programmable Logic Device Family Data Sheet

Table 15. FLEX 8000 3.3-V Device DC Operating Conditions Note (4)									
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
V _{IH}	High-level input voltage		2.0		V _{CC} + 0.3	V			
V _{IL}	Low-level input voltage		-0.3		0.8	V			
V _{OH}	High-level output voltage	I _{OH} = -0.1 mA DC <i>(</i> 5 <i>)</i>	$V_{CC} - 0.2$			V			
V _{OL}	Low-level output voltage	I _{OL} = 4 mA DC <i>(5)</i>			0.45	V			
I _I	Input leakage current	$V_1 = V_{CC}$ or ground	-10		10	μA			
I _{OZ}	Tri-state output off-state current	$V_{O} = V_{CC}$ or ground	-40		40	μA			
I _{CC0}	V _{CC} supply current (standby)	V_1 = ground, no load (6)		0.3	10	mA			

Table 16. FLEX 8000 3.3-V Device CapacitanceNote (7)							
Symbol	Parameter	Conditions	Min	Max	Unit		
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF		
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF		

Notes to tables:

(1) See the Operating Requirements for Altera Devices Data Sheet.

(2) Minimum DC input voltage is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.3 V for input currents less than 100 mA and periods shorter than 20 ns.

(3) The maximum V_{CC} rise time is 100 ms. \overline{V}_{CC} must rise monotonically.

(4) These values are specified in Table 14 on page 29.

(5) The I_{OH} parameter refers to high-level TTL output current; the I_{OL} parameter refers to low-level TTL output current.

(6) Typical values are for $T_A = 25^\circ \text{ C}$ and $V_{CC} = 3.3 \text{ V}$.

(7) Capacitance is sample-tested only.

Figure 16 shows the typical output drive characteristics of 5.0-V FLEX 8000 devices. The output driver is compliant with *PCI Local Bus Specification, Revision* 2.2.

Table 17. FLEX 8000 Internal Timing Parameters Note (1)					
Symbol	Parameter				
t _{IOD}	IOE register data delay				
t _{IOC}	IOE register control signal delay				
t _{IOE}	Output enable delay				
t _{IOCO}	IOE register clock-to-output delay				
t _{IOCOMB}	IOE combinatorial delay				
t _{IOSU}	IOE register setup time before clock; IOE register recovery time after asynchronous clear				
t _{IOH}	IOE register hold time after clock				
t _{IOCLR}	IOE register clear delay				
t _{IN}	Input pad and buffer delay				
t _{OD1}	Output buffer and pad delay, slow slew rate = off, $V_{CCIO} = 5.0 \text{ V C1} = 35 \text{ pF}$ (2)				
t _{OD2}	Output buffer and pad delay, slow slew rate = off, V_{CCIO} = 3.3 V C1 = 35 pF (2)				
t _{OD3}	Output buffer and pad delay, slow slew rate = on, $C1 = 35 \text{ pF}$ (3)				
t _{XZ}	Output buffer disable delay, C1 = 5 pF				
t _{ZX1}	Output buffer enable delay, slow slew rate = off, V_{CCIO} = 5.0 V, C1 = 35 pF (2)				
t _{ZX2}	Output buffer enable delay, slow slew rate = off, V_{CCIO} = 3.3 V, C1 = 35 pF (2)				
t _{ZX3}	Output buffer enable delay, slow slew rate = on, C1 = 35 pF (3)				

Table 18. FLEX 8000 LE Timing Parameters Note (1)				
Symbol	Parameter			
t _{LUT}	LUT delay for data-in			
t _{CLUT}	LUT delay for carry-in			
t _{RLUT}	LUT delay for LE register feedback			
t _{GATE}	Cascade gate delay			
t _{CASC}	Cascade chain routing delay			
t _{CICO}	Carry-in to carry-out delay			
t _{CGEN}	Data-in to carry-out delay			
t _{CGENR}	LE register feedback to carry-out delay			
t _C	LE register control signal delay			
t _{CH}	LE register clock high time			
t _{CL}	LE register clock low time			
t _{CO}	LE register clock-to-output delay			
t _{COMB}	Combinatorial delay			
t _{SU}	LE register setup time before clock; LE register recovery time after asynchronous preset, clear, or load			
t _H	LE register hold time after clock			
t _{PRE}	LE register preset delay			
t _{CLR}	LE register clear delay			

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Figure 19. FLEX 8000 Timing Model

Symbol			Speed	d Grade			Unit
	A	A-2		A-3		-4	1
	Min	Max	Min	Max	Min	Max	
t _{LABCASC}		0.3		0.3		0.4	ns
t _{LABCARRY}		0.3		0.3		0.4	ns
t _{LOCAL}		0.5		0.6		0.8	ns
t _{ROW}		4.2		4.2		4.2	ns
t _{COL}		2.5		2.5		2.5	ns
t _{DIN_C}		5.0		5.0		5.5	ns
t _{DIN_D}		7.2		7.2		7.2	ns
t _{DIN_IO}		5.0		5.0		5.5	ns

T

Symbol		Speed Grade				
	A	-3	A			
İ	Min	Мах	Min	Мах		
t _{LUT}		3.2		7.3	ns	
t _{CLUT}		0.0		1.4	ns	
t _{RLUT}		1.5		5.1	ns	
t _{GATE}		0.0		0.0	ns	
t _{CASC}		0.9		2.8	ns	
t _{CICO}		0.6		1.5	ns	
t _{CGEN}		0.7		2.2	ns	
t _{CGENR}		1.5		3.7	ns	
t _C		2.5		4.7	ns	
t _{CH}	4.0		6.0		ns	
t _{CL}	4.0		6.0		ns	
t _{CO}		0.6		0.9	ns	
t _{COMB}		0.6		0.9	ns	
t _{SU}	1.2		2.4		ns	
t _H	1.5		4.6		ns	
t _{PRE}		0.8		1.3	ns	
t _{CLR}		0.8		1.3	ns	

Table 29. EPF8282AV External Timing Parameters							
Symbol		Spee	d Grade		Unit		
	A	-3	A				
	Min	Max	Min	Max]		
t _{DRR}		24.8		50.1	ns		
t _{ODH}	1.0		1.0		ns		

Table 40. EPF8820A LE Timing Parameters								
Symbol			Speed	Grade			Unit	
	A	-2	A	-3	A	-4		
	Min	Max	Min	Max	Min	Max		
t _{LUT}		2.0		2.5		3.2	ns	
t _{CLUT}		0.0		0.0		0.0	ns	
t _{RLUT}		0.9		1.1		1.5	ns	
t _{GATE}		0.0		0.0		0.0	ns	
t _{CASC}		0.6		0.7		0.9	ns	
t _{CICO}		0.4		0.5		0.6	ns	
t _{CGEN}		0.4		0.5		0.7	ns	
t _{CGENR}		0.9		1.1		1.5	ns	
t _C		1.6		2.0		2.5	ns	
t _{CH}	4.0		4.0		4.0		ns	
t _{CL}	4.0		4.0		4.0		ns	
t _{CO}		0.4		0.5		0.6	ns	
t _{COMB}		0.4		0.5		0.6	ns	
t _{SU}	0.8		1.1		1.2		ns	
t _H	0.9		1.1		1.5		ns	
t _{PRE}		0.6		0.7		0.8	ns	
t _{CLR}		0.6		0.7		0.8	ns	

Table 41. EPF8820A External Timing Parameters									
Symbol			Speed	Grade			Unit		
	A	-2	A-3		A-4				
	Min	Max	Min	Max	Min	Max			
t _{DRR}		16.0		20.0		25.0	ns		
t _{ODH}	1.0		1.0		1.0		ns		

Table 44. EPF81188A LE Timing Parameters								
Symbol	Speed Grade							
	A-2		A-3		A-4		1	
	Min	Max	Min	Max	Min	Max		
t _{LUT}		2.0		2.5		3.2	ns	
t _{CLUT}		0.0		0.0		0.0	ns	
t _{RLUT}		0.9		1.1		1.5	ns	
t _{GATE}		0.0		0.0		0.0	ns	
t _{CASC}		0.6		0.7		0.9	ns	
t _{CICO}		0.4		0.5		0.6	ns	
t _{CGEN}		0.4		0.5		0.7	ns	
t _{CGENR}		0.9		1.1		1.5	ns	
t _C		1.6		2.0		2.5	ns	
t _{CH}	4.0		4.0		4.0		ns	
t _{CL}	4.0		4.0		4.0		ns	
t _{CO}		0.4		0.5		0.6	ns	
t _{COMB}		0.4		0.5		0.6	ns	
t _{SU}	0.8		1.1		1.2		ns	
t _H	0.9		1.1		1.5		ns	
t _{PRE}		0.6		0.7		0.8	ns	
t _{CLR}		0.6		0.7		0.8	ns	

Table 45. EPF81188A External	Timing Parameters
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Symbol	Speed Grade							
	A	-2	A-3		A-4			
	Min	Max	Min	Max	Min	Max	1	
t _{DRR}		16.0		20.0		25.0	ns	
t _{ODH}	1.0		1.0		1.0		ns	

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Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 3 of 3)									
Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)		
GND	5, 26, 47, 68	5, 26, 47, 68	2, 13, 30, 44, 52, 63, 80, 94	19, 44, 69, 94	7, 17, 27, 39, 54, 80, 81, 100,101, 128, 142	C12, D4, D7, D9, D13, G4, G13, H3, H12, J4, J13, L1, M3, M8, M12, M15, N4	12, 13, 34, 35, 51, 63, 75, 80, 83, 93, 103, 115, 126, 131, 143, 155		
No Connect (N.C.)	-	-	-	2, 6, 13, 30, 37, 42, 43, 50, 52, 56, 63, 80, 87, 92, 93, 99	-	-	-		
Total User I/O Pins <i>(9)</i>	64	64	74	64	108	116	116		

Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)								
Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A <i>(1)</i>		
nSP (2)	120	1	R15	207	207	5		
MSELO (2)	117	3	T15	4	4	21		
MSEL1 (2)	84	38	Т3	49	49	33		
nSTATUS (2)	37	83	B3	108	108	124		
nCONFIG (2)	40	81	C3	103	103	107		
DCLK (2)	1	120	C15	158	158	154		
CONF_DONE (2)	4	118	B15	153	153	138		
n₩S	30	89	C5	114	114	118		
nRS	71	50	B5	66	116	121		
RDCLK	73	48	C11	64	137	137		
nCS	29	91	B13	116	145	142		
CS	27	93	A16	118	148	144		
RDYnBUSY	125	155	A8	201	127	128		
CLKUSR	76	44	A10	59	134	134		
ADD17	78	43	R5	57	43	46		
ADD16	91	33	U3	43	42	45		
ADD15	92	31	Т5	41	41	44		
ADD14	94	29	U4	39	40	39		
ADD13	95	27	R6	37	39	37		
ADD12	96	24	Т6	31	35	36		
ADD11	97	23	R7	30	33	31		
ADD10	98	22	Т7	29	31	30		
ADD9	99	21	Т8	28	29	29		
ADD8	101	20	U9	24	25	26		
ADD7	102	19	U10	23	23	25		
ADD6	103	18	U11	22	21	24		
ADD5	104	17	U12	21	19	18		
ADD4	105	13	R12	14	14	17		
ADD3	106	11	U14	12	13	16		
ADD2	109	9	U15	10	11	10		
ADD1	110	7	R13	8	10	9		
ADD0	123	157	U16	203	9	8		
DATA7	144	137	H17	178	178	177		
DATA6	150	132	G17	172	176	175		
DATA5	152	129	F17	169	174	172		

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Pin Name	225-Pin	232-Pin	240-Pin	240-Pin	280-Pin	304-Pin
	BGA EPF8820A	PGA EPF81188A	PQFP EPF81188A	PQFP EPF81500A	PGA EPF81500A	RQFP EPF81500A
nSP (2)	A15	C14	237	237	W1	304
MSELO (2)	B14	G15	21	19	N1	26
MSEL1 (2)	R15	L15	40	38	H3	51
nSTATUS (2)	P2	L3	141	142	G19	178
nCONFIG (2)	R1	R4	117	120	B18	152
DCLK (2)	B2	C4	184	183	U18	230
CONF_DONE (2)	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDYnBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	К3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 3 of 3)								
Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A		
GND	B1, D4, E14, F7, F8, F9, F12, G6, G7, G8, G9, G10, H1, H4, H5, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K6, K7, K8, K9, K11, L15, N3, P1	A1, D6, E11, E7, E9, G4, G5, G13, G14, J5, J13, K4, K14, L5, L13, N4, N7, N9, N11, N14	8, 9, 30, 31, 52, 53, 72, 90, 108, 115, 129, 139, 151, 161, 173, 185, 187, 193, 211, 229	6, 7, 28, 29, 50, 51, 71, 85, 92, 101, 118, 119, 140, 141, 162, 163, 184, 185, 186, 198, 208, 214, 228	D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17	9, 11, 36, 38, 65, 67, 90, 108, 116, 128, 150, 151, 175, 177, 206, 208, 231, 232, 237, 253, 265, 273, 291		
No Connect (N.C.)	_	_	61, 62, 119, 120, 181, 182, 239, 240	_	_	10, 21, 23, 25, 35, 37, 39, 40, 41, 42, 52, 55, 66, 68, 146, 147, 161, 173, 174, 176, 187, 188, 189, 190, 192, 194, 195, 205, 207, 219, 221, 233, 234, 235, 236, 302, 303		
Total User I/O Pins (9)	148	180	180	177	204	204		